Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan



37V/0.8A Stepping Motor Driver

FEATURES

- 4-phase input (W1-2phase excitation enabled; exclusive OR function incorporated for simultaneous-ON prevention)
- Built-in CR chopping (with frequency selected)
- Built-in thermal protection and low voltage detection circuit
- Built-in 5 V power supply
- •32 pin Plastic Shrink Small Outline Package (SSOP Type)

DESCRIPTION

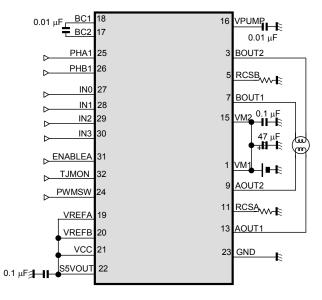
AN44063A is a two channels H-bridge driver LSI. Bipolar stepping motor can be controlled by a single driver LSI.

2-phase,1-2(type 2) phase, W1-2 phase can be selected.

APPLICATIONS

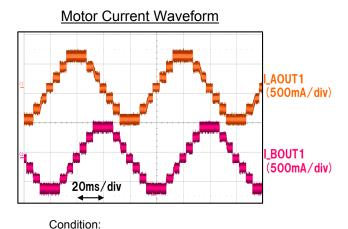
· LSI for stepping motor drives

SIMPLIFIED APPLICATION



Notes)

This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.



VM=24V

Peak motor current:600mA excitation mode :W1-2 phase drive



ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rating | Unit | Note |
|--|------------------------------|--------------|------|------|
| Supply voltage1 (Pin 1, 15) | V _M | 37 | V | *3 |
| Supply voltage2 (Pin 21) | V _{cc} | - 0.3 to + 6 | V | *3 |
| Power dissipation | P _D | 0.427 | W | *1 |
| Operating ambient temperature | T _{opr} | -20 to + 70 | °C | *2 |
| Operating junction temperature | T _j | –20 to + 150 | °C | *2 |
| Storage temperature | T _{stg} | –55 to + 150 | °C | *2 |
| Output pin voltage (Pin 3, 7, 9, 13) | V _{out} | 37 | V | *3 |
| Motor drive current (Pin 3, 7, 9, 13) | I _{OUT} | ± 0.8 | Α | *3 |
| Flywheel diode current (Pin 3, 7, 9, 13) | l _f | 0.8 | Α | *3 |
| | V_{RCSA}, V_{RCSB} | -0.5 to 1.5 | V | |
| | V_{VPUMP} | (VM-1) to 43 | V | _ |
| | V _{BC2} | (VM-1) to 43 | V | _ |
| | V _{BC1} | VM+0.3 | V | _ |
| Input Voltage Denge | V_{VREFA} , V_{VREFB} | -0.3 to 6 | V | _ |
| Input Voltage Range | I _{S5VOUT} | -7 to 0 | mA | _ |
| | V_{PHA1}, V_{PHB1} | -0.3 to 6 | V | _ |
| | V _{PWMSW} | -0.3 to 6 | V | _ |
| | V _{IN0~IN3} | -0.3 to 6 | V | _ |
| | V _{ENABLEA} | -0.3 to 6 | V | |
| ESD | HBM (Human Body Model) | ± 1 | kV | _ |
| | CDM (Charge Device Model) | ± 1 | kV | |

Notes). This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

- *1: The power dissipation shown is the value at T_a = 70°C for the independent (unmounted) LSI package without a heat sink. When using this LSI, refer to the P_D-T_a diagram of the package standard page 4 and use under the condition not exceeding the allowable value.
- *2: Except for the storage temperature, operating ambient temperature, and power dissipation all ratings are for Ta = 25°C. Refer to the package power dissipation prepared else and use under the condition not exceeding the allowable value.
- *3: Do not apply current or voltage from outside to any pin not listed above.

 In the circuit current, (+) means the current flowing into LSI and (–) means the current flowing out of LSI.



POWER DISSIPATION RATING

| Condition | θ _{JA} | PD (Ta=25 °C) | PD (Ta=70 °C) |
|-----------------|-----------------|---------------|---------------|
| Mount on PWB *1 | 96.9 °C/W | 1290mW | 825mW |
| Without PWB | 187.1 °C/W | 668mW | 427mW |

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, supply voltage, load and ambient temperature conditions to ensure that there is enough margin follow the power and the thermal design does not exceed the allowable value.

^{*1:} Glass-Epoxy: 50×50×0.8 (mm)



CAUTION

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note |
|--------------------------------|-----------------------|------|------|----------|------|------|
| Supply valtage range | VM1,VM2 | 16 | 24 | 34 | V | *1 |
| Supply voltage range | V _{CC} | 4.5 | 5 | 5.5 | V | *1 |
| | V _{PWMSW} | 0 | - | V_{CC} | V | |
| | $V_{PHA1,}V_{PHB1}$ | 0 | - | V_{CC} | V | _ |
| Input Voltage Range | V _{IN0~IN3} | 0 | - | V_{CC} | V | _ |
| | V _{ENABLEA} | 0 | - | V_{CC} | V | _ |
| | $V_{VREFA,}V_{VREFB}$ | 0 | - | 5 | V | _ |
| | C _{BC} | - | 0.01 | 1 | μF | _ |
| External Constants | C _{VPUMP} | - | 0.01 | ı | μF | _ |
| | C _{S5VOUT} | - | 0.1 | 1 | μF | _ |
| Operating ambient temperature | Ta ^{opr} | -20 | - | 70 | °C | _ |
| Operating junction temperature | Tj ^{opr} | - | - | 120 | °C | _ |

Note) *1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.



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ELECRTRICAL CHARACTERISTICS

VM=24V, T_a = 25°C±2°C unless otherwise noted.

*1 : Typical Value checked by design.

| _ | | _ | | Limits | | | |
|---|--|--|-----------------------|-----------------------|-----------------|------|------|
| Parameter | Symbol | Condition | Min | Тур | Max | Unit | Note |
| Output Drivers | • | | | | | | |
| High-level output saturation voltage | V _{OH} | I = - 0.5 A | V _M - 0.47 | V _M - 0.31 | _ | V | _ |
| Low-level output saturation voltage | V _{OL} | I = 0.5 A | _ | 0.47 | 0.71 | V | _ |
| Flywheel diode forward voltage | V _{DI} | I = 0.5 A | 0.5 | 1.0 | 1.5 | V | _ |
| Output leakage current | I _{LEAK} | $V_{M} = V_{OUT} = 37 \text{ V},$ $V_{RCS} = 0 \text{ V}$ | _ | 10 | 50 | μА | _ |
| Supply current (with two circuits turned off) | I _M | ENABLEA = 5 V | _ | 4 | 6 | mA | _ |
| Output slew rate 1 | VT _r | Rising edge | _ | 270 | _ | V/µs | *1 |
| Output slew rate 2 | VT _f | Falling edge | _ | 330 | _ | V/μs | *1 |
| Dead time | T _D | _ | _ | 2.8 | _ | μS | *1 |
| I/O Block | | | | | | | |
| Supply current(with two circuits turned off) | I _{cc} | ENABLEA = 5 V | _ | 1.4 | 2.2 | mA | _ |
| High-level IN input voltage | V _{INH} | _ | 2.2 | _ | V _{CC} | V | _ |
| Low-level IN input voltage | V _{INL} | _ | 0 | _ | 0.6 | V | _ |
| High-level IN input current | I _{INH} | IN0 = IN1 = IN2 = IN3 = 5 V | -10 | _ | 10 | μА | _ |
| Low-level IN input current | I _{INL} | IN0 = IN1 = IN2 = IN3 = 0 V | -15 | _ | 15 | μА | _ |
| High-level PHA1/PHB1 input voltage | V_{PHAH} V_{PHBH} | _ | 2.2 | _ | V _{cc} | V | _ |
| Low-level PHA1/PHB1 input voltage | V _{PHAL} V _{PHBL} | _ | 0 | _ | 0.6 | V | _ |
| High-level PHA1/PHB1 input current | I _{PHAH} I _{PHBH} | PHA1 = PHB1 = 5 V | 25 | 50 | 100 | μА | _ |
| Low-level PHA1/PHB1 input current | I _{PHAL} | PHA1 = PHB1 = 0 V | -15 | _ | 15 | μА | _ |
| High-level ENABLEA input voltage | V _{ENABLEAH} | _ | 2.2 | _ | V _{CC} | V | _ |
| Low-level ENABLEA input voltage | V _{ENABLEAL} | _ | 0 | _ | 0.6 | V | _ |
| High-level ENABLEA input current | I _{ENABLEAH} | ENABLEA = 5 V | -10 | | 10 | μΑ | |
| Low-level ENABLEA input current | I _{ENABLEAL} | ENABLEA = 0 V | -15 | _ | 15 | μА | _ |
| High-level PWMSW input voltage | V _{PWMSWH} | _ | 2.2 | _ | V _{CC} | V | _ |
| Low-level PWMSW input voltage | V _{PWMSWL} | _ | 0 | _ | 0.6 | V | _ |



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ELECRTRICAL CHARACTERISTICS (continued)

VM=24V, T_a = 25°C±2°C unless otherwise noted.

| | Doromotor | | Parameter Symbol Condition | | Limits | | Unit | Note |
|-----|--------------------------------|----------------------|--|------|--------|------|------|------|
| | Parameter | Symbol | Condition | Min | Тур | Max | Unit | Note |
| I/O | Block (Continued) | | | | | | | |
| | High-level PWMSW input current | I _{PWMSWH} | PWMSW = 5 V | 25 | 50 | 100 | μА | |
| | Low-level PWMSW input current | I _{PWMSWL} | PWMSW = 0 V | -15 | _ | 15 | μА | _ |
| Toı | que Control Block | | | | | | | |
| | Input bias current | I _{REFA} | V _{REFA} = 5 V V _{REFB} = 5 V | 70 | 100 | 130 | μА | _ |
| | PWM frequency1 | f _{PWM1} | PWMSW = 0 V | 34 | 52 | 70 | kHz | _ |
| | PWM frequency2 | f _{PWM2} | PWMSW = 5 V | 17 | 26 | 35 | kHz | |
| | Pulse blanking time | T _B | V _{REFA} = V _{REFB} = 0 V | 0.38 | 0.75 | 1.12 | μS | |
| | Cmp threshold H (100%) | VT _H | IN0 = IN1 = 0 V IN2 = IN3 = 0 V | 475 | 500 | 525 | mV | |
| | Cmp threshold C (67%) | VT _C | IN0 = 5 V, IN1 = 0 V IN2 = 5 V, IN3 = 0 V | 308 | 333 | 359 | mV | _ |
| | Cmp threshold L (33%) | VT _L | IN0 = 0 V, IN1 = 5 V IN2 = 0 V, IN3 = 5 V | 151 | 167 | 184 | mV | |
| Ref | ference Voltage Block | | | | | _ | | |
| | Reference voltage | V _{S5 VOUT} | I _{S5 VOUT} = – 2.5 mA | 4.5 | 5.0 | 5.5 | V | |
| | Output impedance | Z _{S5 VOUT} | I _{S5 VOUT} = – 5 mA | _ | 18 | 27 | Ω | |



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ELECRTRICAL CHARACTERISTICS (continued)

VM=24V, T_a = 25°C±2°C unless otherwise noted.

| | Douguestou | Cumhal | Condition | Limits | | | 11!4 | Nata |
|--------------------|--|-------------------|-----------|--------|-----|-----|--------|------|
| | Parameter | Symbol | Condition | Min | Тур | Max | Unit N | Note |
| Thermal Protection | | | | | | | | |
| | Thermal protection operating temperature | TSD _{on} | _ | _ | 150 | _ | °C | *1 |
| | Thermal protection hysteresis width | ΔTSD | _ | _ | 40 | _ | °C | *1 |

Note) *1 :Typical Value checked by design.



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| PIN CONFIGURATION | Top View | _ |
|-------------------|----------|----------------|
| VM1 EEEEE | 1 32 | TJMON |
| N.C. Editoria | 2 31 | ENABLEA |
| BOUT2 | 3 30 | ::::::::: IN3 |
| N.C. | 4 29 | :::::::: IN2 |
| RCSB EEEEE | 5 28 | :::::::::: IN1 |
| N.C. | 6 27 | IN0 |
| BOUT1 | 7 26 | PHB1 |
| N.C. | 8 25 | PHA1 |
| AOUT2 | 9 24 | PWMSW |
| N.C. | 10 23 | GND |
| RCSA Estates | 11 22 | S5VOUT |
| N.C. Essesse | 12 21 | VCC |
| AOUT1 | 13 20 | VREFB |
| N.C. | 14 19 | VREFA |
| VM2 | 15 18 | BC1 |
| VPUMP Essession | 16 17 | BC2 |
| | | 1 |

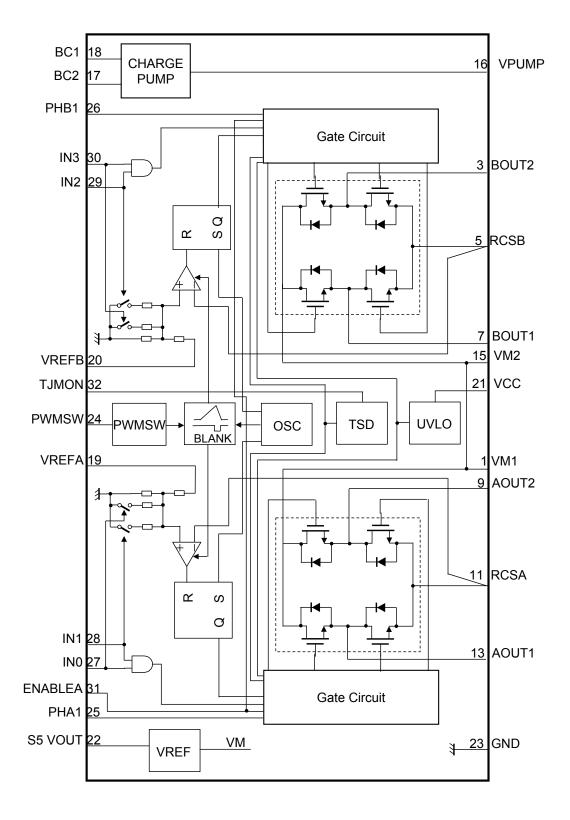
PIN FUNCTIONS

| Pin No. | Pin name | Туре | Description | |
|----------------------|----------|----------------|--|--|
| 1 | VM1 | Power supply | Motor power supply 1 | |
| 2,4,6,8, 10,12,14 | N.C. | _ | No Connection | |
| 3 | BOUT2 | Output | Phase B motor drive output 2 | |
| 5 | RCSB | Input / Output | Phase B current detection | |
| 7 | BOUT1 | Output | Phase B motor drive output 1 | |
| 9 | AOUT2 | Output | Phase A motor drive output 2 | |
| 11 | RCSA | Input / Output | Phase A current detection | |
| 13 | AOUT1 | Output | Phase A motor drive output 1 | |
| 15 | VM2 | Power supply | Motor power supply 2 | |
| 16 | VPUMP | Output | Charge Pump circuit output | |
| 17 | BC2 | Output | Charge Pump capacitor connection 2 | |
| 18 | BC1 | Output | Charge Pump capacitor connection 1 | |
| 19 | VREFA | Input | Phase A torque reference voltage input | |
| 20 | VREFB | Input | Phase B torque reference voltage input | |
| 21 | VCC | Power supply | Signal power supply | |
| 22 | S5VOUT | Output | Internal reference voltage (5V output) | |
| 23 | GND | Ground | Signal ground | |
| 24 | PWMSW | Input | PWM frequency selection input | |
| 25 | PHA1 | Input | Phase A phase selection input | |
| 26 | PHB1 | Input | Phase B phase selection input | |
| 27 | IN0 | Input | Phase A output torque control 1 | |
| 28 | IN1 | Input | Phase A output torque control 2 | |
| 29 | IN2 | Input | Phase B output torque control 1 | |
| 30 | IN3 | Input | Phase B output torque control 2 | |
| 31 | ENABLEA | Input | Phase A/B Enable/Disable CTL | |
| 32 | TJMON | Output | VBE monitor use | |

Notes) Concerning detail about pin description, please refer to OPERATION and APPLICATION INFORMATION section.

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FUNCTIONAL BLOCK DIAGRAM



Note) This block diagram is for explaining functions. The part of the block diagram may be omitted, or it may be simplified.

Doc No. TA4-EA-04524

Revision. 2



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OPERATION

1. Control mode

1) Truth table

| ENABLEA | PHA1/PHB1 | AOUT1/BOUT1 | AOUT2/BOUT2 |
|---------|-----------|-------------|-------------|
| "L" | "H" | "H" | "L" |
| "L" | "L" | "L" | "H" |
| "H" | _ | OFF | OFF |

| IN0/IN2 | IN1/IN3 | Output Current |
|---------|---------|---|
| "L" | "L" | (VREF / 10) × (1 / Rs) = I _{OUT} |
| "H" | "L" | (VREF / 10) × (1 / Rs) × (2 / 3) = I _{OUT} |
| "L" | "H" | (VREF / 10) × (1 / Rs) × (1 / 3) = I _{OUT} |
| "H" | "H" | 0 |

Note1) Rs: current detection region

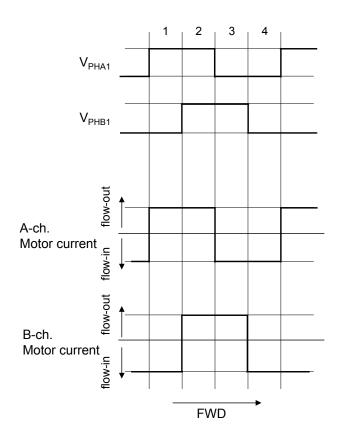
Note2) When ENABLEA = "H" or IN0 = IN1 = "H"/IN2 = IN3 = "H", all output transistors switch off at the same time.

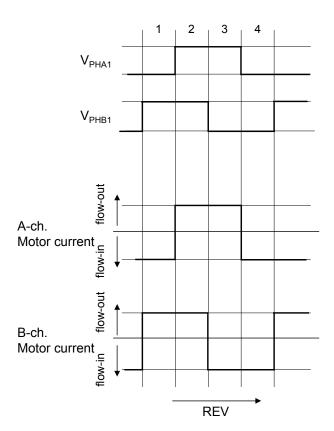
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OPERATION (continued)

- 1. Control mode (continued)
- 2) Drive of full step (4steps sequence) (IN0 to IN3 = const.)



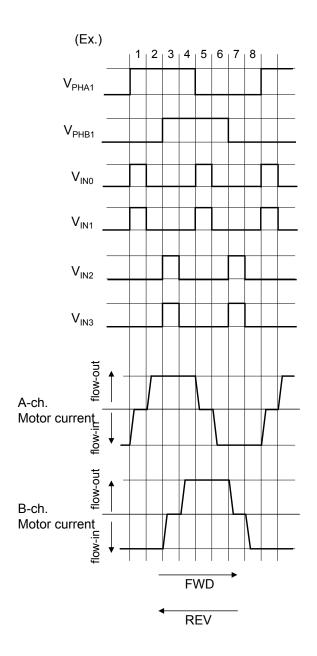


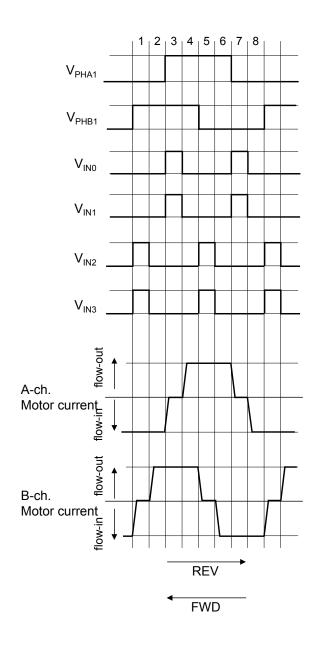
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OPERATION (continued)

- 1. Control mode(continued)
- 3) Drive of half step (8steps sequence)

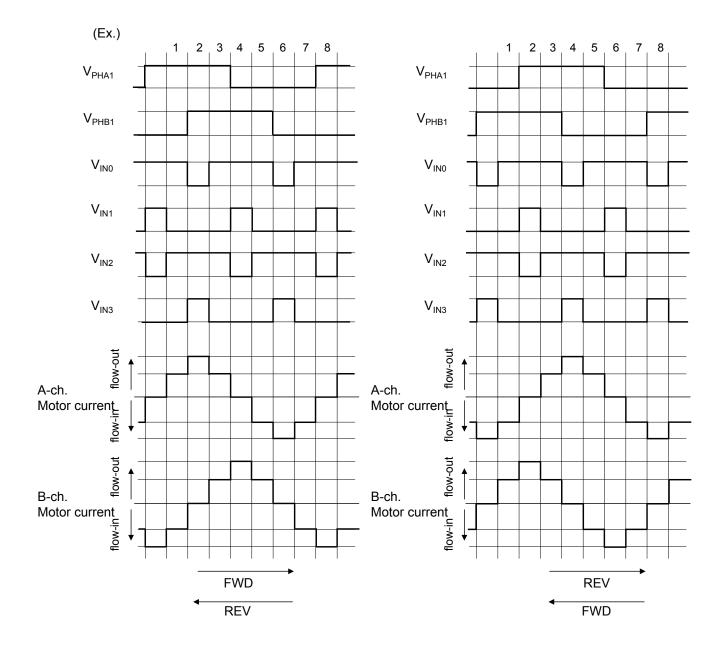






OPERATION (continued)

- 1. Control mode(continued)
- 4) 1-2 phase excitation (8steps sequence)

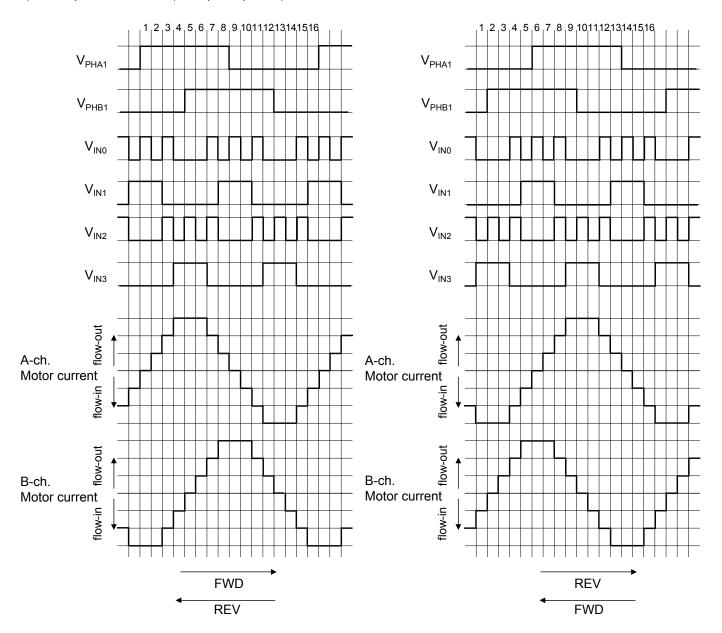




OPERATION (continued)

1. Control mode(continued)

5) W1-2 phase excitation (16steps sequence)



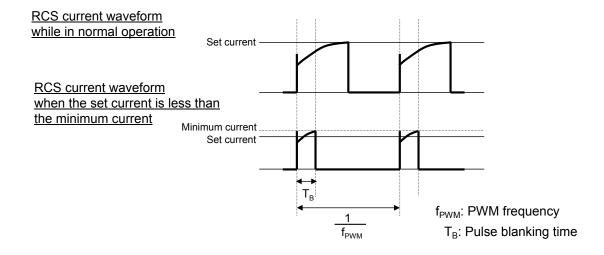
APPLICATIONS INFORMATION

1. Usage Notes

1) In order to prevent mistakes in current detection resulting noise, this LSI is provided with a pulse blanking time of 0.75 μs (typ.).

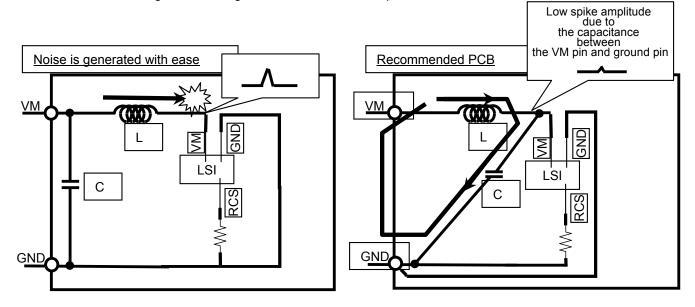
The motor current will not be less than the current determined by blanking time. Pay utmost attention at the time of minute current control.

The graph on the right-hand side shows the relationship between the pulse blanking time and minute current value. The increase or decrease in the motor current is determined by the resistance of the internal winding of the motor.



2) A high current flows into the LSI. Therefore, the common impedance of the PCB pattern cannot be ignored. Take the following points into consideration and design the PCB pattern of the motor.

A high current flows into the line between the VM1 (Pin 1) and VM2 (Pin 15) pins. Therefore, noise is generated with ease at the time of switching due to the inductance (L) of the line, which may result in the malfunctioning or destruction of the LSI (see the circuit diagram on the left-hand side). As shown in the circuit diagram on the right-hand side, the escape way of the noise is secured by connecting a capacitor to the connector close to the VM pin of the LSI. This makes it possible to suppress the direct VM pin voltage of the LSI. Make the settings as shown in the circuit diagram on the right-hand side as much as possible.



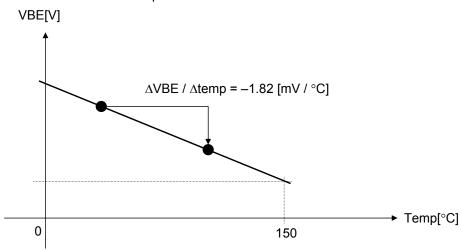


APPLICATIONS INFORMATION (continued)

Usage Notes (continued)

3) In the case of measuring the chip temperature of the LSI,measure the voltage of TJMON (Pin 32) and presume chip temperature from following data. Use the following data as reference data. Before applying the LSI to a product, conduct a sufficient reliability test of the LSI along with the evaluation of the product with the LSI incorporated.

The temperature characteristic of TJMON



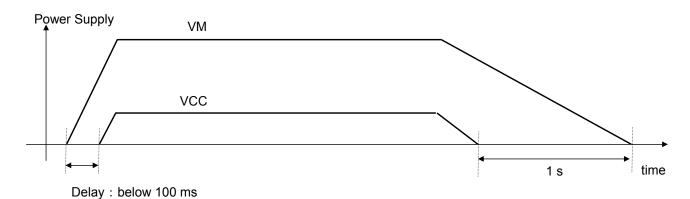
4) Power Supply Sequence

If two types of power supply are used
Rise: This LSI is recommended rise of 5 V power supply before rise of 24 V power supply.
Fall: Although there is no particular rule, check that VM fall time is about 1sec.

When recommended sequence is difficult, take the diagram below indicates into consideration and design.

Also, rise slew rate design

VM : below 0.1 V/µs, VCC : below 0.1 V/µs



If one type of power supply is used Rise slew rate design

VM: below 0.1 V/µs

5) Check the risk that is caused by the failure of external components.

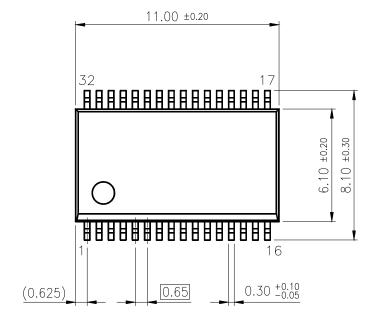
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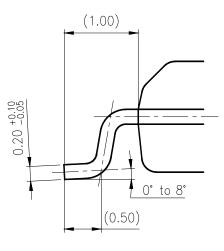
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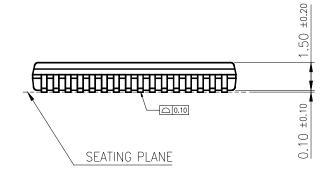
PACKAGE INFORMATION (Reference Data)

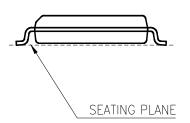
Package Code:SSOP032-P-0300B

unit:mm









| Body Material | : | Epoxy Resin |
|--------------------|---|--------------|
| Lead Material | : | Cu Alloy |
| Lead Finish Method | • | SnBi Plating |

Established: 2006-09-12 : 2012-10-10 Revised



IMPORTANT NOTICE

- 1. The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- 2. When using the LSI for new models, verify the safety including the long-term reliability for each product.
- 3. When the application system is designed by using this LSI, be sure to confirm notes in this book. Be sure to read the notes to descriptions and the usage notes in the book.
- 4. The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information de-scribed in this book.
- 5. This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.
- 6. This LSI is intended to be used for general electronic equipment.

Consult our sales staff in advance for information on the following applications: Special applications in which exceptional quality and reliability are required, or if the failure or malfunction of this LSI may directly jeopardize life or harm the human body.

Any applications other than the standard applications intended.

- (1) Space appliance (such as artificial satellite, and rocket)
- (2) Traffic control equipment (such as for automobile, airplane, train, and ship)
- (3) Medical equipment for life support
- (4) Submarine transponder
- (5) Control equipment for power plant
- (6) Disaster prevention and security device
- (7) Weapon
- (8) Others: Applications of which reliability equivalent to (1) to (7) is required

It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the LSI described in this book for any special application, unless our company agrees to your using the LSI in this book for any special application.

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AN44063A

USAGE NOTES

1. When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.

- 2. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- 3. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
- 4. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 5. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- 6. The LSI is destructed under an abnormal condition, such as the short-circuiting between the output and VM pins, output and ground pins, or output pins (i.e., load short-circuiting), in which case smoke may be generated. Pay utmost attention to the use of the LSI.

Pay special attention to the following pins so that they are not short-circuited with the VM pin, ground pin, other output pin, or current detection pin.

- (1) AOUT1 (Pin 13), AOUT2 (Pin 9), BOUT1 (Pin 7), BOUT2 (Pin 3)
- (2) BC2 (Pin 17), VPUMP (Pin 16)
- (3) VM1 (Pin 1), VM2 (Pin 15), VCC(Pin 21), S5 VOUT(Pin 22)
- (4) RCSA (Pin 11), RCSB (Pin 5)

The higher the current capacity of power supply is, the higher the possibility of the above destruction or smoke generation. Therefore, it is recommended to take safety countermeasures, such as the use of a fuse.

- 7. The protection circuit is for maintaining safety against abnormal operation. Therefore, the protection circuit should not work during normal operation.
 - Especially for the thermal protection circuit, if the area of safe operation or the absolute maximum rating is momentarily exceeded due to output pin to VM short (Power supply fault), or output pin to GND short (Ground fault), the LSI might be damaged before the thermal protection circuit could operate.
- 8. Unless specified in the product specifications, make sure that negative voltage or excessive voltage are not applied to the pins because the device might be damaged, which could happen due to negative voltage or excessive voltage generated during the ON and OFF timing when the inductive load of a motor coil or actuator coils of optical pick-up is being driven.
- 9. The product which has specified ASO (Area of Safe Operation) should be operated in ASO.
- 10. Verify the risks which might be caused by the malfunctions of external components.

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USAGE NOTES (continued)

11. Perform thermal design work with consideration of a sufficient margin to keep the power dissipation based on supply voltage, load, and ambient temperature conditions.
(The LSI is recommended that junctions are designed below 70% to 80% of Absolute Maximum Rating.)

- 12. Set the value of the capacitor between the VPUMP and GND pins so that the voltage on the VPUMP (Pin 16) will not exceed 43 V in any case regardless of whether it is a transient phenomenon or not while the motor standing by is started.
- 13. This LSI employs a PWM drive method that switches the high-current output of the output transistor. Therefore, the LSI is apt to generate noise that may cause the LSI to malfunction or have fatal damage. To prevent these problems, the power supply must be stable enough. Therefore, the capacitance between the VCC and GND pins must be a minimum of 0.1 μ F and the one between the VM and GND pins must be a minimum of 47 μ F and as close as possible to the LSI so that PWM noise will not cause the LSI to malfunction or have fatal damage.

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